

# LIQUID CRYSTAL DISPLAY MODULE

## **Product Specification**

CUSTOMER	Standard
CUSTOMER PART NUMBER	
PRODUCT NUMBER	DMT050WVNXNT0-1A

Authorised By	Created By
Luo Luo	Eric Wan
Date: 20-Jan-17	Date: 20-Jan-17

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#### **REVISION RECORD**

Rev.	Date	Page	Chapt.	Comment	ECN no.
1.0	20-Jan-17			Initial Release	ECN8017

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## **1 MAIN FEATURES**

ITEM	CONTENTS		
Screen Size	5.0" Diagonal		
Display Format	480 x RGB x 854 Dots		
N° of Colour	65K/262K/16.7M		
TFT Active Area	61.63 mm (H) x 109.65 mm (V)		
LCD Type	TFT		
Mode	IPS Transmissive / Normally Black		
Viewing Direction	Full view		
Interface	3-line SPI + 16/18/24-bit RGB interface		
Driver IC	ILI9806E or equivalent		
Backlight Type	LED		
Operating Temperature	-20°C ~ +70°C		
Storage Temperature	-30°C ~ +80°C		
RoHS compliant	Yes		

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## **2** MECHANICAL SPECIFICATION

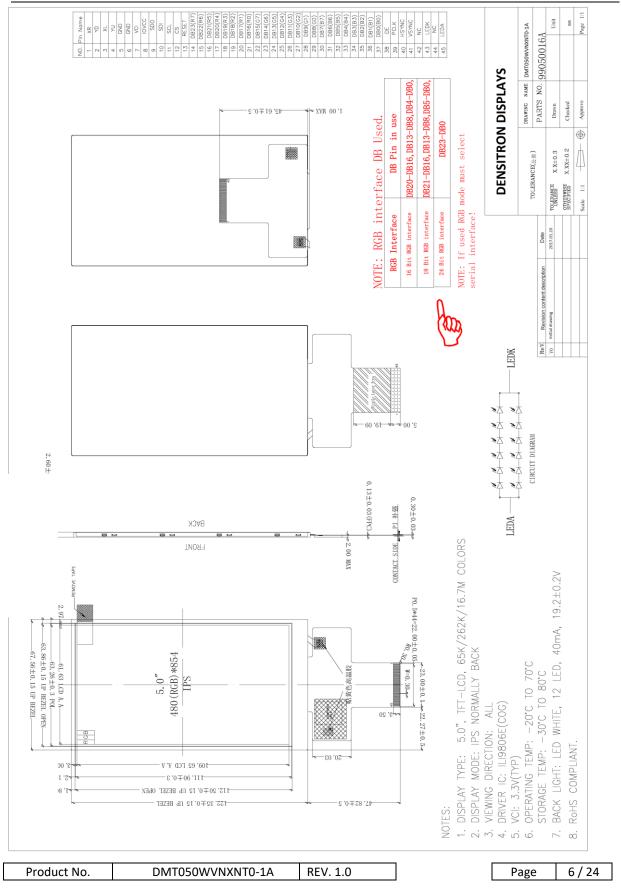
## 2.1 MECHANICAL CHARACTERISTICS

ITEM	CHARACTERISTIC	UNIT
Display Format 480 x RGB x 854 Dots		Dots
Overall Dimensions	67.56 mm (H) x 122.35 mm (V) x 2.6 mm (D)	mm
Active Area	61.63 mm (H) x 109.65 mm (V)	mm
pixel Pitch	0.128 (H) x 0.128 (V)	mm
Weight	28	g

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## 2.2 MECHANICAL DRAWING





## **3** ELECTRICAL SPECIFICATION

## 3.1 ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Condition	Min	Max	Unit	Note
Power Supply Voltage	VCI	Ta=25°C	-0.3	4.6	V	
Digital Interface Supply Voltage	IOVCC	Ta=25°C	-0.3	4.6	V	
Operating Temperature	ТОР		-20	70	°C	1
Storage Temperature	TST		-30	80	°C	1,2,3

Note 1. 90 % RH Max for Ta<50 °C, and 60% RH for Ta≥50°C.

- Note 2. In case of below 0°C, the response time of liquid crystal (LC) becomes slower and the colour of panel becomes darker than normal one. Level of retardation depends on temperature, because of LC's characteristic.
- Note 3. Only operation is guaranteed at operating temperature. Contrast, response time, another display quality are evaluated at +25°C.

### 3.2 DC ELECTRICAL CHARACTERISTICS

ltem	Symbol	Condition	Min	Тур	Max	Unit	Note
Supply Voltage	VCI		3.0	3.3	4.2	V	
Digital Interface Supply Voltage	IOVCC		1.8	3.3	3.6	V	
	VIH		<b>0.7V</b> cı	-	Vcı	V	
Input Voltage for Logic	VIL		GND	-	0.3 Vci	V	
	VOH		Vci -0.4	-	-	V	
Output Voltage for Logic	VOL		GND	-	Vci +0.4	V	
Current Consumption	ICC		-	30	-	mA	1

Note 1: The specified power consumption is under the conditions of VCI=3.3V, FV=60Hz.

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### 3.3 INTERFACE PIN ASSIGNMENT

Pin NO.	Symbol	Function				
1	XR	Not Connected				
2	YD	Not Connected				
3	XL	Not Connected				
4	YU	Not Connected				
5	GND	Crowned				
6	GND	Ground				
7	VCI	Analogue power supply, 3.3V.				
8	IOVCC	I/O power supply voltage (1.8V~3.3V)				
9	SDO	Serial data output pin in serial bus system interface. If not used, please leave this pin open.				
10	SDI (SDA)	Serial data input pin used for the SPI Interface. SDI : Serial data input pin SDA : Serial data input/output bidirectional pin				
11	SCL	Serial Clock Input				
12	CSX	Chip select signal. Low: chip can be accessed; High: chip cannot be accessed. If not used, please connect to GND.				
13	RESX	Reset pin, active low				
14-37	DB23-DB16 (R7-R0) DB15-DB8 (G7-G0) DB7-DB0 (B7-B0)	24-bit bi-directional data bus. 24-bit bus: use DB23-DB0 16-bit bus: use DB20-DB16, DB13-DB8, DB4-DB0 18-bit bus: use DB21-D16, DB13-DB8, DB5-DB0 Please connect unused pins to GND.				
38	DE	Data Enable signal for RGB (DPI) I/F mode. Low : access enabled				
39	PCLK	Pixel clock signal for RGB (DPI) I/F mode.				
40	HSYNC	Line synchronizing signal for RGB (DPI) I/F mode.				
41	VSYNC	Frame synchronizing signal for RGB (DPI) I/F mode.				
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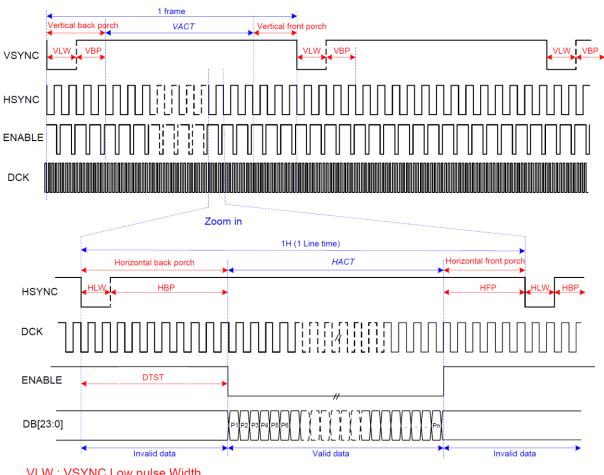
Pin NO.	Symbol	Function
42	NC	Not connected
43	LEDK	Cathode pin of backlight
44	NC	Not connected
45	LEDA	Anode pin of backlight

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## 3.4 TIMING CHARACTERISTICS

Please refer to IC ILI9806E datasheet for more information



## 3.4.1 Display RGB (DPI) Interface Timing

VLW : VSYNC Low pulse Width HLW : HSYNC Low pulse Width DTST : Data Transfer Startup Time Pn : pixel 1, pixel 2…, pixel n.

Parameter	Symbols	Min.	Тур.	Max.	Units
Frame Rate	FR	54		66	fps
Horizontal Low Pulse width	HLW	1		-	DOTCLK
Horizontal Back Porch	HBP	2		126	DOTCLK
Horizontal Address	HACT		480		DOTCLK
Horizontal Front Porch	HFP	2		-	DOTCLK
Vertical Low Pulse width	VLW	1		126	Line
Vertical Back Porch	VBP	1		126	Line
Vertical Address	VACT			864	Line
Vertical Front Porch	VFP	1		255	Line
Data Clock	DCLK	16.6		41.7	MHz

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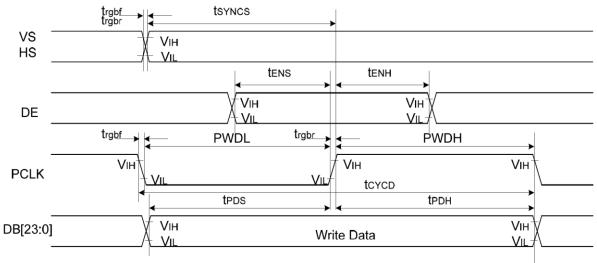
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3.4.2 Display Parallel RGB (24/18/16 bit) DPI Interfa	ce Timing
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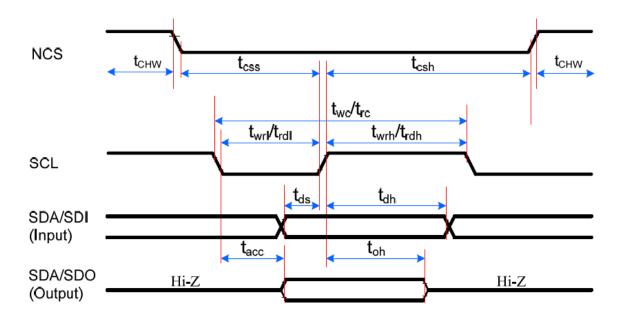
Signal	Symbol	Parameter	min	max	Unit	Description
VS/ HS	tSYNCS	VS/HS setup time	5	-	ns	
	tSYNCH	VS/HS hold time	5	-	ns	
DE	tENS	DE setup time	5	-	ns	
	tENH	DE hold time	5	-	ns	
DB[23:0]	tPOS	Data setup time	5	-	ns	24/18/16-bit bus
	tPDH	Data hold time	5	-	ns	RGB interface mode
PCLK	PWDH	PCLK high-level period	13	-	ns	mode
	PWDL	PCLK low-level period	13	-	ns	
	tCYCD	PCLK cycle time	28	-	ns	
	trgbr , trgbf	PCLK,HS,VS rise/fall time	-	15	ns	

Note: Ta=-20 to 70C, VCI=2.5V to 3.6V, GND=0V



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## 3.4.3 Display Serial interface Timing characteristics (3-line SPI System)

Signal	Symbol	Parameter	min	max	Unit	Description
tcss		Chip select time (Write)	15	-	ns	
CSX	tcsh	Chip select hold time (Read)	15	-	ns	
	tchw	CS "H" pulse width	40	-	ns	
	twc	Serial clock cycle (Write)	30	-	ns	
	twrh	SCL "H" pulse width (Write)	10	-	ns	
	twrl	SCL "L" pulse width (Write)	10	-	ns	
SCL	trc	Serial clock cycle (Read)	150	-	ns	
	trdh	SCL "H" pulse width (Read)	60	-	ns	
	trdl	SCL "L" pulse width (Read)	60	-	ns	
SDA/SDO	tacc	Access time (Read)	10	100	ns	For maximum CL=30pF
(Output)	toh	Output disable time (Read)	15	100	ns	For minimum CL=8pF
SDA/SDI	tds	Data setup time (Write)	10	-	ns	
(Input)	tdh	Data hold time (Write)	10	-	ns	

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### 3.5 POWER SEQUENCE

### 3.5.1 RESET Input Timing

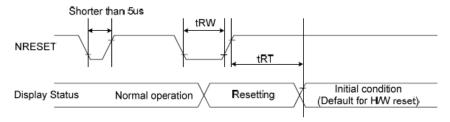


Figure 102 Reset Timing

Table	41	Reset	Timing
THE	<b>-</b>		

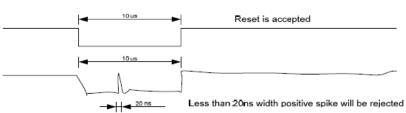
Signal	Symbol	Parameter	Min	Max	Unit
	tRW	Reset pulse duration	10		us
RESX	4DT	Deasterned		5(note 1,5)	ms
	tRT Reset cancel			120 (note 1,6,7)	ms

Note:

- The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from OTP to registers. This loading is done every time when there is H/W reset cancel time (tRT) within 5 ms after a rising edge of RESX.
- Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the Table 43.

RESX Pulse	Action			
Shorter than 5us	Reset Rejected			
Longer than 9us	Reset			
Between 5us and 9us	Reset starts			

- During the Resetting period, the display will be blanked (The display is entering blanking sequence, which
  maximum time is 120 ms, when Reset Starts in Sleep Out mode. The display remains the blank state in
  Sleep In mode.) and then return to Default condition for Hardware Reset.
- 4. Spike Rejection also applies during a valid reset pulse as shown below:



#### Figure 103 Positive Noise Pulse during Reset Low

- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.
- It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

#### 3.5.2 Power on/off Sequence

Please refer to IC ILI9806E datasheet.

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#### Table 42 Reset Descript



## **4 OPTICAL SPECIFICATION**

## 4.1 OPTICAL CHARACTERISTICS

Driving condition:	VCI = 3.3V, VSS = 0V
Backlight:	IF=40mA
Measured temperature:	$Ta = 25^{\circ}C$

	Item Symbol		Condition	MIN	ТҮР	ΜΑΧ	Unit	Note
	Response Time TR+TF		θ=Φ=0°	-	30	35	ms	2
	Contrast Ratio	CR	Normal Viewing Angle	-	800	-		3
	Left	θL		-	80	-	deg	
g Angle	Right	θR	CD > 10	-	80	-	deg	4
Viewing Angle	Up	φU	CR ≥ 10	-	80	-	deg	
	Down	φD		-	80	-	deg	
	Red	Rx		-	0.659	-	-	
t	Reu	Ry		-	0.322	-	-	
Colour Chromaticity	Green	Gx		-	0.290	-	-	
rom	Green	Gy	CR ≥ 10	-	0.588	-	-	_
с Ч	Blue	Bx	CK 2 10	-	0.134	-	-	5
nolo	ыце	Ву		-	0.124	-	-	
S	White	Wx		-	0.298	-	-	
	White	Wy		-	0.328	-	-	
Centr	e Brightness		lf=40mA	450	500	-	cd/m²	6
Bright	ness Distribution			80	-	-	%	7

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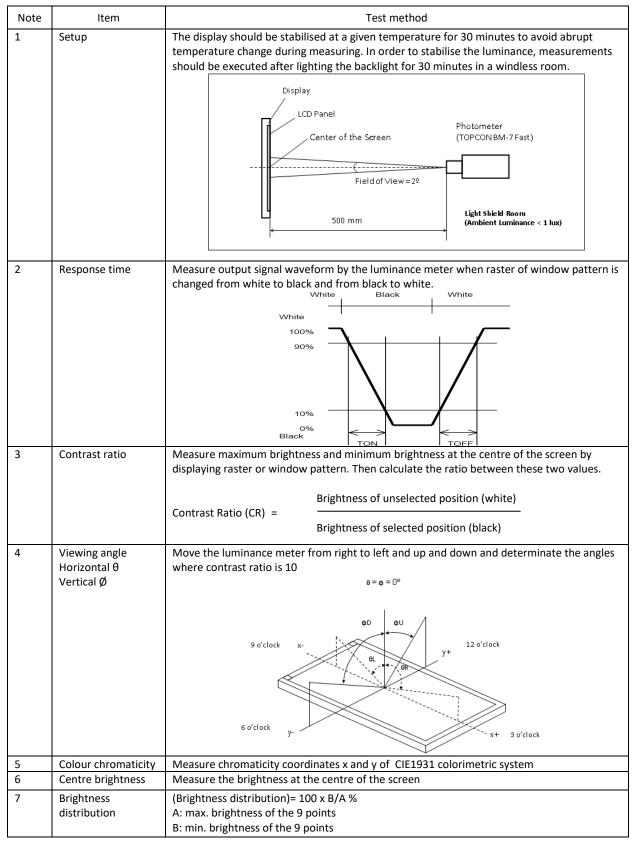
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#### 4.1.1 Test Method

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## **5** BACKLIGHT SPECIFICATION

## 5.1 LED DRIVING CONDITIONS

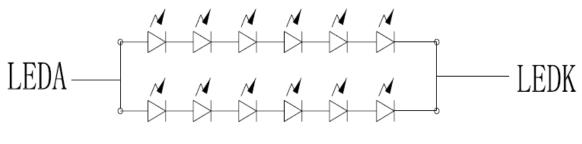
Item	Symbol	Condition	Min	Тур	Max	Unit	
Forward Current	IF	Ta=25 °C,	30	40	-	mA	
Forward Voltage	VF	Ta= 25°C,		19.2		V	
LED life time	Hr	Ta= 25°C,	-	-	50000	Hour	

#### The back light system is edge-lighting type with 12 chips White LED

Note:

- The lifetime of the LED is defined as a period till the brightness of the LED decreases to the half of its initial value.
- This figure is given as a reference purpose only, and not a guarantee.
- This figure is estimated for an LED operating alone.
   The performance of an LED may differ when assembled as a monitor together with a TFT panel due to different environmental temperature.
- Estimated lifetime could vary on a different temperature and usually higher temperature could reduce the life significantly.

## 5.2 LED CIRCUIT



CIRCUIT DIAGRAM

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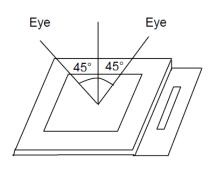


## **6** QUALITY ASSURANCE SPECIFICATION

### 6.1 DELIVERY INSPECTION STANDARDS

#### 6.1.1 Inspection Conditions

Inspection distance: $30 \text{ cm} \pm 2 \text{ cm}$ Viewing angle: $\pm 45^{\circ}$ 



### 6.1.2 Environmental Conditions

Ambient temperature:	25°C ±5°C
Ambient humidity:	65±10% RH
Ambient illumination:	300~700 lux

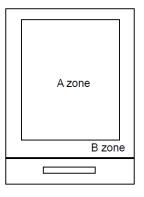
### 6.1.3 Sampling Conditions

- 1. Lot size: quantity of shipment lot per model
- 2. Sampling method:

Sampling Plan		GB/T 2828-2003		
		Normal inspection, Single Sampling, Class $\Pi$		
Major Defect		0.65%		
AQL	Minor Defect	1.5%		

### 6.1.4 Definition of Area

A zone: active area B zone: viewing area



### 6.1.5 Basic Principle

A set of sample to indicate the limit of acceptable quality level shall be discussed should a dispute occur.

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## 6.1.6 Inspection Criteria

Number	Items	Criteria(mm)			
1.0 LCD Crack/Broken	(1) The edge of LCD broken				
NOTE:		X Y Z			
X: Length Y: Width		≤3.0mm <li><inner border="" li="" line="" of="" seal="" the="" ≤t<=""></inner></li>			
Z: Height L: Length of ITO, T: Height of LCD	(2)LCD corner broken	XYZ $\leq 3.0$ mm $\leq L$ $\leq T$			
	(3) LCD crack	Crack Not allowed			

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Number	Items	Criteria (mm)						
2.0	Spot defect	① light dot(LCD stain)	/TP/Polarizer bl	ack/white s	pot , li	ight dot, p	inhole, den	
		Zone	Ac	cep able Q	ty			
		Size (mm)	Α	В		С		
	x	Ф≤0.10	Ignor	e				
		0.10<Φ≤0.20	3( distance	≧10mm)				
	Φ=(X+Y)/2	0.20<Φ≤0.25	2		— IÇ	gnor		
		Φ>0.25	0					
		②Dim spot(LCD/	/TP/Polarizer di	m dot, light	leakag	ge、dark s	spot)	
		Zone	Acceptable Qty		ty			
		Size (mm)	A	В		С		
		Ф≤0.1	Ignore					
		0.10<Ф≤0.20	3( distance≧10mm)					
		0.20<Φ≤0.30	2			gnore		
		Φ > 0.30         0           ③ Polarizer accidented spot						
		Zone	Acceptable Qty				]	
		Size (mm)	А	В		С	]	
		Ф≤0.2	lgno	ore				
		0.3<Φ≤0.5	2( distance	≧10mm)		lgnore		
		Φ>0.5	0					
	Line defect (LCD/TP			0		01.	1	
	/Polarizer	Width(mm)	Length(mm		eptable B	-	-	
	black/white	Ф≤0.03	Ignoe	A		С	-	
	line, scratch,	©.03 <w≤0.05< td=""><td>L≤3.0</td><td>N≤2</td><td></td><td>Ignore</td><td></td></w≤0.05<>	L≤3.0	N≤2		Ignore		
	stain)	0.05 <w≤0.08< td=""><td>L≤2.0</td><td>N≤2</td><td></td><td>.9.1010</td><td></td></w≤0.08<>	L≤2.0	N≤2		.9.1010		
		0.08 <w< td=""><td></td><td>ine as spot o</td><td></td><td></td><td>-</td></w<>		ine as spot o			-	

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	Polarizer	Zone Size (mm)	A	Acceptable C B	Qty C	
3.0	Bubble	Φ≤0.2 0.2<Φ≤0.4 0.4<Φ≤0.6 0.6<Φ	Ign 3(distance 2	ore e≧10 m) 2	Ignore	
4.0	SMT	According to IPC-/ part are major defe				efect and missing

	Size $\Phi(mm)$	Ac	ceptable (	Qty
	Size Φ(mm)	А	В	С
TP bubble/	Ф≤0.1	Igno	ore	
	0.1<Φ≤0.25	• • • • •	<b>.</b>	Ignore
accidented	0.25<Ф≤0.3	2		Ignore
spot	0.3<Ф	0		
Assembly deflection	beyor	nd the edge	of backlig	ht ≤0.15mm

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-						
5.0	TP Related	Newton Ring	Newton Rir NG Newton Rir OK			<ul> <li>1規律性</li> <li>1規律性</li> <li>2.挑射単生</li> <li>(人人人)</li> <li>(以牛顿环)</li> </ul>
		TP corner				
		broken	X	Y	Z	x
		X : length	X≤3.0mm	Y≤3.0mm	Z <lcd thickness</lcd 	z
		Y : width	* Circuitry b	roken is no	ot allowed.	~
		Z : height				
		TP edge	x	Y	Z	X AY
		broken			Z <lcd< td=""><td>Z Z Z</td></lcd<>	Z Z Z
		X : length	X≤6.0mm	Y≤2.0mm	thickness	
		Y:width				
		Z : height	* Circuitry b	oroken is no	ot allowed.	
		,				· ·

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	TP no function	Not allowed

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### 6.1.7 Classification of Defects

Visual defects (except no or wrong label) are treated as minor defects, while electrical defects are treated as major defects.

Two minor defects are equal to one major defect in lot sampling inspection.

### 6.1.8 Identification / Marking criteria

Any unit with illegible / wrong / double or no marking / label shall be rejected.

## 6.2 DEALING WITH CUSTOMER COMPLAINTS

### 6.2.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

### 6.2.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of nonconforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

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## 7 RELIABILITY SPECIFICATION

## 7.1 RELIABILITY TESTS

	Test Item	Test Condition	
	High Temperature Storage	Ta= 80°C	96h
	Low Temperature Storage	Ta=-30°C	96h
	Temperature Cycle Storage		C ON/OFF, 20 cycles. ON time over 10 ime over 10 seconds
	High Temperature Operation	Tp= 70°C	96h
st	Low Temperature Operation	Tp= -20°C	96h
Durability Test	High Temperature & Humidity Operation	Tp= 70°C RH Non condensir	= 90% 96h Ig
Durab	ESD Test	150Pf, 330Ω, ± Points/panel, 1	6KV (Contact)/±8KV (Air), 5 L0 times/point
	Thermal Shock Resistance	5 cycles of ope temperature fo normal temper then taking it o	ould be allowed to stand the following ration: TSTL for 30 minutes -> normal or 5 minutes -> TSTH for 30 minutes -> rature for 5 minutes, as one cycle, out and drying it at normal and allowing it stand for 24 hours
	Box Drop Test	1 Corner 3 Edg	es 6 faces, 66 cm (Medium Box)

Note: Ta=ambient temperature Tp= Panel temperature

Notes:

1. No dew condensation to be observed.

2. The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.

3. No cosmetic or functional defects should be allowed.

4. Total current consumption should be less than twice the initial value.

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## 8 HANDLING PRECAUTIONS

#### Safety

If the LCD panel breaks, be careful not to get the liquid crystal fluid in your mouth or in your eyes. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water.

#### Mounting and Design

Place a transparent plate (e.g. acrylic, polycarbonate or glass) on the display surface to protect the display from external pressure. Leave a small gap between the transparent plate and the display surface.

When assembling with a zebra connector, clean the surface of the pads with alcohol and keep the surrounding air very clean.

Design the system so that no input signal is given unless the power supply voltage is applied.

#### Caution during LCD cleaning

Lightly wipe the display surface with a soft cloth soaked with Isopropyl alcohol, Ethyl alcohol or Trichlorotriflorothane.

Do not wipe the display surface with dry or hard materials that will damage the polariser surface. Do not use aromatic solvents (toluene and xylene), or ketonic solvents (ketone and acetone).

#### Caution against static charge

As the display uses C-MOS LSI drivers, connect any unused input terminal to VDD or VSS. Do not input any signals before power is turned on. Also, ground your body, work/assembly table and assembly equipment to protect against static electricity.

#### Packaging

Displays use LCD elements, and must be treated as such. Avoid strong shock and drop from a height. To prevent displays from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.

#### Caution during operation

It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life. Direct current causes an electrochemical reaction with remarkable deterioration of the display quality. Give careful consideration to prevent direct current during ON/OFF timing and during operation. Response time is extremely delayed at temperatures lower than the operating temperature range while, at high temperatures, displays become dark. However, this phenomenon is reversible and does not mean a malfunction or a display that has been permanently damaged. If the display area is pushed on hard during operation, some graphics will be abnormally displayed but returns to a normal condition after turning off the display once. Even a small amount of condensation on the contact pads (terminals) can cause an electro-chemical reaction which causes missing rows and columns. Give careful attention to avoid condensation.

#### Storage

Store the display in a dark place where the temperature is  $25^{\circ}C \pm 10^{\circ}C$  and the humidity below 50%RH. Store the display in a clean environment, free from dust, organic solvents and corrosive gases.

Do not crash, shake or jolt the display (including accessories).

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